

6NM60-S

Power MOSFET

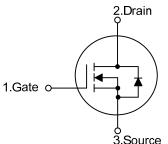
6A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

The **UTC 6NM60-S** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

- * $R_{DS(on)} \le 1.4\Omega$ @ V_{GS} =10V, I_D =3.0A
- * Improved dv/dt capability
- * Fast switching
- * 100% avalanche tested
- SYMBOL

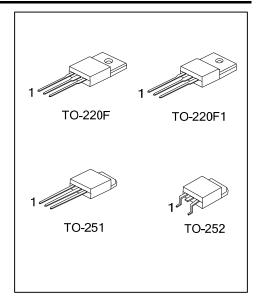


3.Source ■ ORDERING INFORMATION

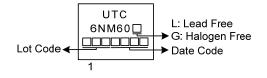
Ordering Number			Daakaga	Pin Assignment			Decking	
	Lead Free	Halogen Free	- Package	1	2	3	Packing	
	6NM60L-TF1-T	6NM60G-TF1-T	TO-220F1	G	D	S	Tube	
6NM60L-TF3-T		6NM60G-TF3-T	TO-220F	G	D	S	Tube	
	6NM60L-TM3-T	6NM60G-TM3-T	TO-251	G	D	S	Tube	
	6NM60L-TN3-R	6NM60G-TN3-R	TO-252	G	D	S	Tape Reel	
Note:	Pin Assignment: G: Gate	D: Drain S: Source						

Note: Pin Assignment: G: Gate D: Drain S: Source

6NM60G-TF1-T	(1) T: Tube, R: Tape Reel
(2)Package Type	 (2) TF3: TO-220F, TF1: TO-220F1, TM3: TO-251,
(3)Green Package	TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free



MARKING





■ **ABSOLUTE MAXIMUM RATINGS** (T_c = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	600	V
Gate-Source Voltage		V _{GSS}	±30	V
Continuous Drain Current		I _D	6.0	А
Pulsed Drain Current (Note 2)		I _{DM}	24	А
Avalanche Current (Note 2)		I _{AR}	1.4	A
Single Pulsed Avalanche Energy (Note 3)		E _{AS}	141	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
	TO-220F/TO-220F1		40	W
Power Dissipation	TO-251/TO-252		55	40 W 55 W
Junction Temperature		TJ	+150	
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 144 mH, I_{AS} = 1.4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

4. I_{SD} ≤ 6.0A, di/dt ≤ 200A/µs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
lunction to Ambiant	TO-220F/TO-220F1	θ _{JA}	62.5	°C/W	
Junction to Ambient	TO-251/TO-252		110		
lunction to Coop	TO-220F/TO-220F1	0	3.13	°C 1.11	
Junction to Case	TO-251/TO-252	θ _{JC}	2.27	°C/W	



■ ELECTRICAL CHARACTERISTICS (T_c=25°C, unless otherwise specified)

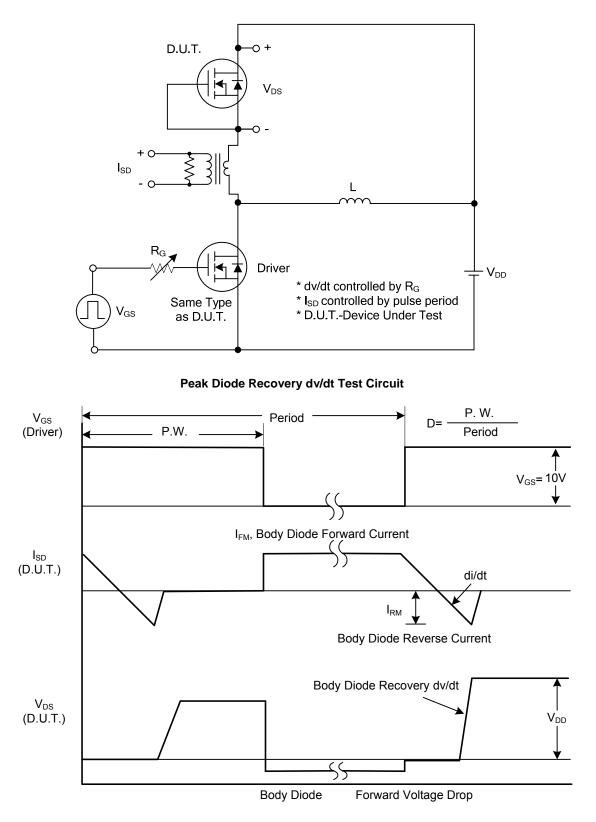
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	Voltage BV_{DSS} $V_{GS} = 0V, I_D = 250\mu A$		600			V		
Drain-Source Leakage Current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V			10	μA		
Gate-Source Leakage Current	I _{GSS}	V _{GS} = 30V, V _{DS} = 0V			100	nA		
Gale-Source Leakage Current		V_{GS} = -30V, V_{DS} = 0V			-100	nA		
ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V		
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 3.0A			1.4	Ω		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C _{ISS}			255		рF		
Output Capacitance	C _{OSS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		179		рF		
Reverse Transfer Capacitance	C _{RSS}			24		рF		
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)	Q_{G}			44		nC		
Gate-Source Charge	Q_{GS}	V _{DS} =50V, I _D =1.3A, V _{GS} =10V I _G =100μA (Note 1,2)		4.5		nC		
Gate-Drain Charge	Q_{GD}	IG-100μΑ (Note 1,2)		7.8		nC		
Turn-On Delay Time (Note 1)	t _{D(ON)}			43		nS		
Turn-On Rise Time	t _R	V _{DD} =30V, I _D =0.5A, R _G =25Ω		58		nS		
Turn-Off Delay Time	t _{D(OFF)}	(Note 1,2)		120		nS		
Turn-Off Fall Time	t _F			50		nS		
DRAIN-SOURCE DIODE CHARACTERISTICS	S AND MAXI	MUM RATINGS						
Maximum Body-Diode Continuous Current	Is				6	Α		
Maximum Body-Diode Pulsed Current	I _{SM}				24	Α		
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	I _S =6.0A, V _{GS} =0V			1.4	V		
Reverse Recovery Time (Note 1)	t _{rr}	I _S =6.0A, V _{GS} =0V,		260		nS		
Reverse Recovery Charge	Qrr	dI _F /dt=100A/µs		2.1		μC		

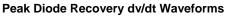
Notes: 1. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2%.

2. Essentially independent of operating ambient temperature.



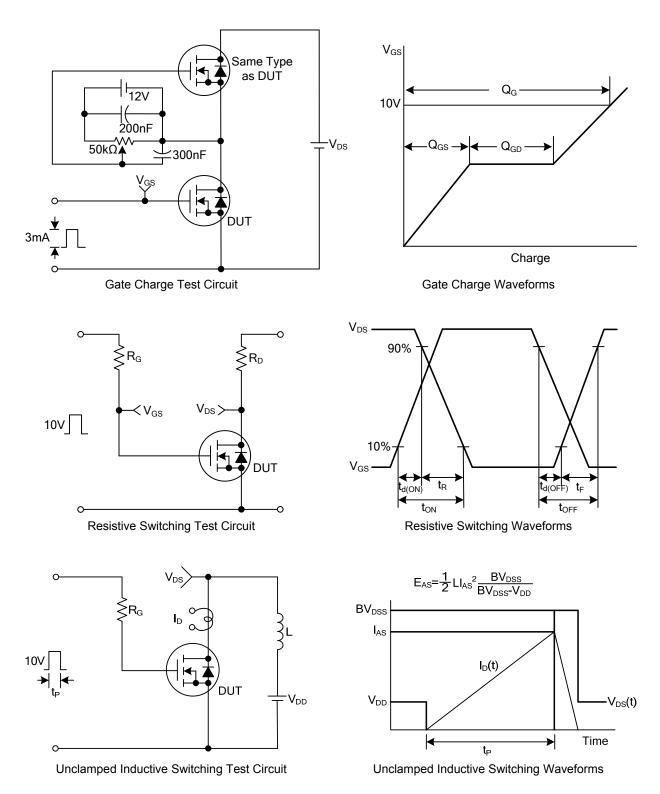
TEST CIRCUITS AND WAVEFORMS







TEST CIRCUITS AND WAVEFORMS (Cont.)





UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

